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Customer No. 30425

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: : Tsiu Chiu Chan, et al.  
Serial No. : 09/160,824  
Filed : September 25, 1998  
For : STACKED MULTI-COMPONENT INTEGRATED CIRCUIT  
MICROPROCESSOR  
Group No. : 2826  
Examiner : T. L. Dickey

**MAIL STOP RCE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF MAILING BY FIRST CLASS MAIL**

Sir:

The undersigned hereby certifies that the following documents:

1. Request for Continued Examination (RCE) Transmittal (in duplicate);
2. Petition Under 37 C.F.R. 1.47(a);
3. Declaration Under 37 C.F.R. 1.131;
4. Check in the amount of \$880.00 for the RCE filing fee (\$750.00) and Petition filing fee (\$130.00); and
5. A postcard receipt;

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to MAIL STOP RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 25, 2003.

Date: 8/25/03

Date: 8-25-03

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